

ITW

[10191/3212A]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s) : URBAN et al. Confirmation No.: 8189
Serial No. : 10/676,295
Filed : September 30, 2003
For : METHOD OF ETCHING STRUCTURES INTO AN
ETCHING BODY USING A PLASMA
Examiner : S. Ahmed
Art Unit : 1765
Customer No. : 26646

**I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:
Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450
on**

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Date 11/21/06 Atty's Reg. # 41,172
Atty's Signature *LS*
**DERVIS MAGISTRE
KENYON & KENYON LLP**

RESPONSE TRANSMITTAL

SIR:

Please find a Response transmitted herewith for filing in the above-identified patent application.

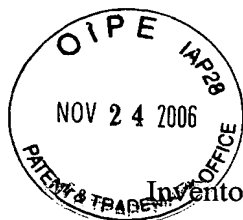
No fee is believed to be required. However, if any fee is required, please use Deposit Account No. 11-0600. A duplicate copy of this transmittal letter is enclosed for that purpose.

Respectfully submitted,
KENYON & KENYON LLP

Dated: 11/21/06

JS: LS (to No. 41,172)
By: *LS*
Gerard A. Messina
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RESPONSE

SIR:

In response to the Office Action dated August 21, 2006, please amend the above-identified application as set forth below.

Amendments to the Specification do not appear in this paper.

Amendments to the Claims do not appear in this paper.

Amendments to the Drawings do not appear in this paper.

Remarks begin on page 2 of this paper.